

## SCV EPS Chapter Barbeque



**Back row:** From left to right: *Tiwei Wei* (Student Chapter Relations), *Dongkai Shanggguan* (IEEE Fellow; Distinguished Lecturer), *Bernie Siegal* (IEEE Fellow; Semi-Therm Founder; Former Chapter Chair), *Annette Teng* (Chapter Chair), *Chandan Bhat* (Chapter Secretary), *Wendem Beyene* (Distinguished Lecturer; Steering Committee), *Sandy Chew* (Vice Secretary). **Front row:** *Paul Wesling* (IEEE Fellow, Distinguished Lecturer, Chapter Webmaster), *Luu Nguyen* (Program Director; IEEE Fellow)

EX-COM Not present: *Azmat Malik* (Treasurer) *Rockwell Hsu* (Vice Chair) *Ravi Agrawal* (Co-vice Chair) & *Zia Karim* (Steering Committee)

On Saturday, August 21, free from the hustle and bustle of the workweek, it was a day of relaxation. The smoke that had blanketed the sky around Silicon Valley had cleared up just in time for our EPS SCV Chapter summer barbeque. Indeed, Paul and Gail Wesling's pool glistened welcomingly as we basked in the California sun. But it lay largely ignored (except for several of our children) as the current and past ExCom officers of the Santa Clara Valley EPS Chapter happily met up after a long pandemic-caused absence.

Discussions were rampant, both informative and friendly, from Tiwei Wei, Student Chapter Relations and a postdoctoral researcher at Stanford University, explaining his research interests of electronics cooling solutions for high-performance systems, to Bernie Siegal, the former Chapter Chair, pulling out an IEEE GRID magazine showcasing his youthful self on the cover receiving the IEEE Fellow Award. It's a copy he has kept since 1997.

As the salmon baked on the grill, Paul (consummate host and winner of 2021 Presidential Award) shared snippets of what made his widely known talks centering on the history and origins of

Silicon Valley so captivating – of a man who, undeterred by the decimation of his first San Francisco building in the 1906 earthquake, moved to San Jose where he would start the nation's first-ever regularly scheduled radio station broadcast.

A delicious feast of salmon, plus veggie burgers, potatoes, beans, and more came, prepped and cooked by Gail. With it, the tides of conversation shifted to global conferences and future plans, both for the members and for IEEE.



To sweeten up the day, the three C's – cookies, chocolate, and cake – were served as the party wrapped up with a meeting led by Chapter Chair Annette Teng (I, a senior at UC Davis, attended the barbeque as her current summer intern at Promex Inc., where I have been working on an exciting electronic packaging project). Two officers joined the meeting via phone. Together, the officers and other volunteers discussed ideas for student outreach programs – from developing informative animated videos, to attract kids of all ages into the semiconductor field, to suggestions to increase student involvement in the chapter by attending college job fairs and potentially waiving student membership fees. We talked about Wendem's DTMES Conference in Addis Ababa, Ethiopia next February, as well as the upcoming REPP and 5<sup>th</sup> HI Roadmap Symposium. We recapped our chapter's webinar program, organized this year by Luu – we'll have 29 of these WebEx events this year, most of which have on-demand videos (edited by Paul) posted on IEEE.tv, for viewers worldwide.

And so, with bellies full and blueprints of plans laid out, the barbeque came to a close. Such as it is, after a day of fun, the ExCom of the SCV Chapter hopes to make a difference in the fields of electronics packaging, both in Silicon Valley and the rest of the world.

**Written by Claire Wong & Annette Teng**

